



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants : Koichi Ono Confirmation No.: 1733  
Serial No. : 10/626,759  
Filed : July 21, 2003  
TC/A.U. : 1731  
Examiner :

Docket No. : 03-485  
Customer No. : 34704

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313

INFORMATION DISCLOSURE STATEMENT

Dear Sir:

In accordance with the requirements of 37 CFR 1.97 and 1.98, Applicant hereby submits the prior art listed hereinbelow, copies enclosed, which prior art was cited in the corresponding application.

- (1) U.S. Patent No. 6,406,636 entitled METHODS FOR WAFER TO WAFER BONDING USING MICROSTRUCTURES, By Vaganov, patented June 18, 2002. The patent is attached hereto.
- (2) U.S. Patent Application Publication No. 2002/0053399 entitled METHODS FOR FABRICATING ENCLOSED MICROCHANNEL STRUCTURES, By Soane et al., patented May 9, 2002. The patent is attached hereto.
- (3) International Publication No. WO 01/91902 entitled METHODS AND DEVICES FOR SEALING MICROCHIP RESERVOIR DEVICES, By Shawgo et al., published December 6, 2001. The patent is attached hereto.

(4) International Publication No. WO 02/07884 entitled  
COMPOSITIONS AND METHODS FOR LIQUID METERING IN  
MICROCHANNELS, By Handique et al., published January  
31, 2002. The patent is attached hereto.

(5) International Publication No. WO 01/98759 entitled  
INTEGRATED OPTICAL WAVEGUIDES FOR MICROFLUIDIC ANALYSIS  
SYSTEMS, By Johnck et al., published December 27, 2001.  
The patent is attached hereto.

The undersigned hereby certifies that each item contained in  
this information disclosure statement was first cited in the  
European search report issued on December 9, 2003.

The undersigned submits the above-identified references for  
independent consideration by the Examiner and does not make any  
admission that these references are or are not material to the  
present invention or that these references are or are not prior  
art with respect to the present invention.

Respectfully submitted,

Koichi Ono.

By

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Date: January 29, 2004

I hereby certify that this correspondence is being deposited with the United States Postal  
Service with sufficient postage as first class mail in an envelope addressed to: "Commissioner  
for Patents, P.O. Box 1450, Alexandria, VA 22313" on January 29, 2004.

  
Rachel Piscitelli

